### SPC58xN



# 32-bit Power Architecture<sup>®</sup> microcontroller for automotive ASIL-D and security applications

Data brief



#### **Features**



- · AEC-Q100 qualified
- 32-bit Power Architecture VLE compliant CPU cores:
  - Five enhanced main e200z4256n3 cores, dual issue, two paired in lockstep
  - Floating Point, End-to-End Error Correction
- 6576 KB (6288 KB code flash + 288 KB data flash) on-chip flash memory:
  - supports read during program and erase operations, and multiple blocks allowing EEPROM emulation
  - Supports read while read between the two code Flash partitions.
- 128 KB on-chip general-purpose SRAM (in addition to 384 KB included in the CPUs)
- 96-channel direct memory access controller (eDMA)
- Comprehensive new generation ASIL-D safety concept
  - ASIL-D of ISO 26262
  - FCCU for collection and reaction to failure notifications
  - Memory Error Management Unit (MEMU) for collection and reporting of error events in memories
  - Cyclic redundancy check (CRC) unit
- Junction temperature range -40 °C to 165 °C
- Dual-channel FlexRay controller
- Hardware Security Module (HSM)
- GTM344 generic timer module
  - Intelligent complex timer module
  - 144 channels (48 input and 96 output)
  - 5 programmable fine grain multi-threaded cores
  - 61 KB of dedicated RAM

- 24-bit wide channels
- Enhanced analog-to-digital converter system with:
  - 1 supervisor 12-bit SAR analog converter
  - 2 separate 10-bit SAR analog converter
  - 4 separate fast 12-bit SAR analog converters
  - 6 separate 16-bit Sigma-Delta analog converter with programmable decimation filters
- SAR ADC Queued digital interfaces for individual channel ordering and command sequencing
- Communication interfaces
  - 7 LINFlexD modules
  - 8 deserial serial peripheral interface (DSPI) modules
  - 7 modular controller area network (MCAN) modules, and one time-triggered controller area network (M-TTCAN), all supporting flexible data rate (ISO CAN-FD)
- One Ethernet controller 10/100 Mbps, compliant IEEE 802.3-2008
- Flexible Power Supply options:
  - External Regulators (1.2 V core, 3.3 V -5 V IO)
  - Single internal SMPS regulator
- Nexus development interface (NDI) per IEEEISTO 5001-2003 standard, with some support for 2010 standard
- Boot assist Flash (BAF) supports factory programming using a serial bootload through the asynchronous CAN or LIN/UART

Contents SPC58xN

## **Contents**

1	Description	3
2	SPC58 N line main benefits	4
3	Block diagram	5
4	ECOPACK	6
5	Ordering information	7
8	Revision history	Q

SPC58xN Description

### 1 Description

SPC58 N line MCU, based on Power Architecture® Technology, is designed for mission-critical automotive applications where most stringent safety standards and real-time performance really matters.

SPC58 N line high performance and real time capabilities, combined with ISO26262 ASIL D functional safety compliance and embedded security, address high and mid powertrain applications, Electric vehicles.



### 2 SPC58 N line main benefits

The SPC58 N line family system benefits are the followings:

- Optimized platform architecture (dedicated Multi-cores, Local memories, etc...) for best-in-class system performance MCU
- True ASIL-D Safety Element out of Context (SEooC) concept relying on HW measures for reduced SW overhead
- Generic Timer Module (GTM) optimized for Powertrain use while minimizing CPU load
- Hardware Security Module (HSM)
- Hardware Sensor Interface (SENT, PSI5)
- Enhanced Communication (LFAST, Ethernet, Micro Second Bus (MSB), etc...)
- Increased high dynamic signals acquisition through SD-ADC
- Innovative built-in concept allowing on-chip emulation with production-compatible package (176-pin eLQFP and 292-pin LFBGA)



SPC58xN **Block diagram** 

#### **Block diagram** 3

Figure 1 shows the top-level block diagram.

**x2** Debug **HSM** INTC Power Architecture™ Power Architecture™ JTAG e200z4d e200z4d Nexus 8k-d 16k-i 8k-d Cache Cache Cache Cache eDMA 64 eDMA VLE FPU LSP VLE FPU LSP CMPU CMPU STM Crossbar Switch Crossbar Switch Memory Protection Unit Memory Protection Unit MEMU Cal Bus 64K 64K **FMPLL** 6M SRAM SRAM FCCU IRC 4x 64k Periph. Periph. FLASH 1\* PSI5-S Bridge Bridge 1\* PSI5 1\* PSI5 1 \* PIT 1\*PIT **TSENS** CRC CRC ADCQ ADC GTM ADC supervisor System/Platform Connectivity Product / Application Specific Memory

Figure 1. SPC58 N line family block diagram

ECOPACK SPC58xN

### 4 ECOPACK

In order to meet environmental requirements, ST offers these devices in different grades of *ECOPACK* packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.



# 5 Ordering information

Table 1. Device summary

Reference	Part number
SPC58xN	SPC58NN84C3, SPC58NN84E7, SPC58NN80C3, SPC58NN80E7



Revision history SPC58xN

# 6 Revision history

Table 2. Document revision history

Date	Revision	Changes
17-Sep-2015	1	Initial release.
29-Jan-2020	2	Updated: - RPN; - Features.

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